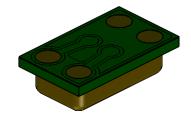


"Slim UltraMini" SiSonic™ Microphone Specification With Maximum RF Protection and Ultra Narrow Design





Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143





1. DESCRIPTION AND APPLICATION

1.1 DESCRIPTION "Slim UltraMini" Surface Mount Silicon Microphone with Maximum RF Protection and Ultra Narrow Design

1.2 APPLICATION Consumer electronics

2. PART MARKING

Identification Number Convention

S 1 2 3

4 5 6 7

S: Identification Marking

"S" - Knowles SiSonic Production

"E" - Knowles Engineering Samples

Digits 1-7: Job Identification Number

3. MATERIALS STATEMENT

- 3.1 Meets the requirements of the European RoHS directive, 2002/95/EC as amended.
- 3.2 Meets the requirements of the industrystandard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.
- 3.3 Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in annex A, B, and C of the "Montreal Protocol on Substances that deplete the Ozone Layer."

4. TEMPERATURE RANGE

4.1 Operating Temperature Range: -40°C to +100°C

4.2 Storage Temperature Range: -40°C to +100°C



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5. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Unit
Supply Voltage, V_{DD} to Ground	-0.5, +5.0	V
OUT to Ground	-0.3, V _{DD} +0.3	V
Input Current to Any Pin	±5	mΑ

Stresses at these Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. The device may not function when operated at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications". Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

6. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: 23 ±2°C, 60-70% R.H., V_{DD}(min) ≤ V_{DD} ≤ V_{DD} (max), no load, unless otherwise specified

Parameter	Symbol	condition		Limits		Unit
raidmeter	Symbol	Condition	Min.	Nom.	Max.	OFILE
Supply Voltage ¹	V _{DD}		1.5		3.6	V
Current Consumption ¹	IDD			120	160	μΑ
Directivity				Omni-di	rectional	
Sensitivity ¹	S	94 dB SPL @ 1kHz	-45	-42	-39	dBV/Pa
Signal to Noise Ratio	SNR	94 dB SPL @ 1kHz, A-weighted		59		dB (A)
Output Impedance	Zout	@ 1kHz			400	Ω
Total Harmonic	THD	100 dB SPL @ 1kHz, Rload > 3kHz			1	%
Distortion	טווו	115 dB SPL @ 1kHz, Rload > 3kHz			10	%
Polarity		Increasing sound pressure	Decreasing output voltage			

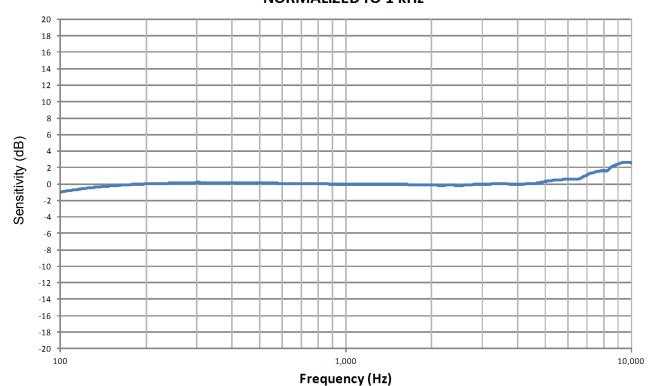
^{100%} tested





7. FREQUENCY RESPONSE CURVE

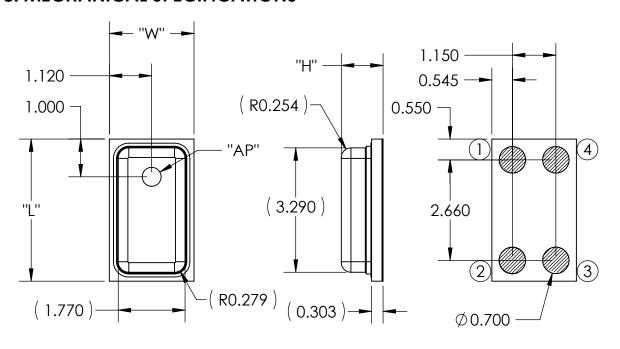
TYPICAL FREE FIELD RESPONSE NORMALIZED TO 1 kHz







8. MECHANICAL SPECIFICATIONS



ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH (L)	3.760	±0.100	mm
WIDTH (W)	2.240	±0.100	mm
HEIGHT (H)	1.100	±0.100	mm
ACOUSTIC	Ø0 500	±0.100	no no
PORT (AP)	Ø0.500	±0.100	mm

PIN OUTPUT		
PIN #	FUNCTION	
1	POWER (VDD)	
2	GROUND	
3	GROUND	
4	OUTPUT	

Note:

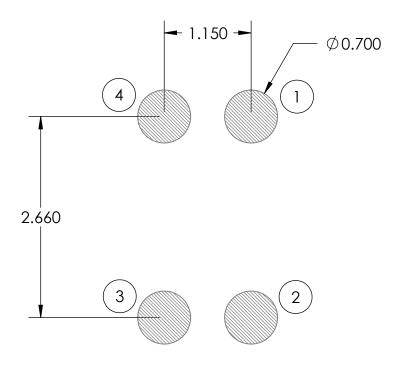
Dimensions are in milimeters unless otherwise specified.

Tolerance ± 0.150 mm unless otherwise specified.





9. RECOMMENDED CUSTOMER LAND PATTERN

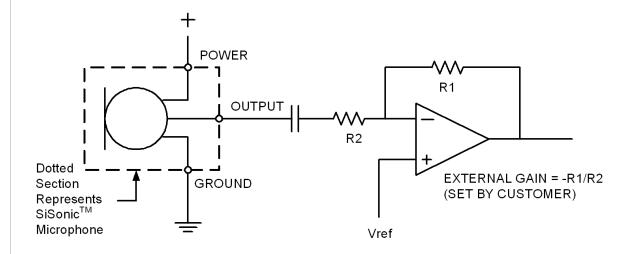


Note: Contact Knowles for Solder Stencil Information





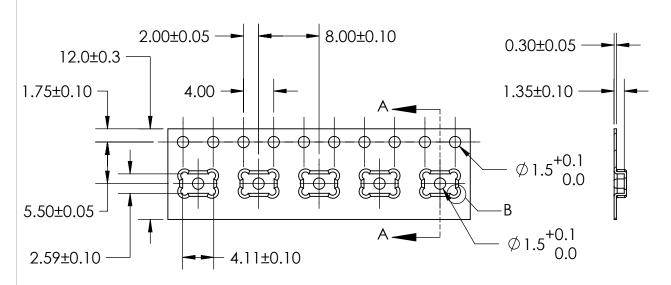
10. RECOMMENDED INTERFACE CIRCUIT

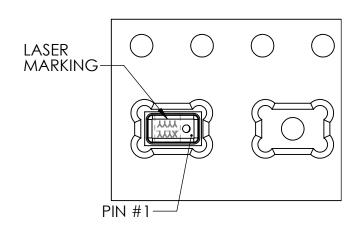


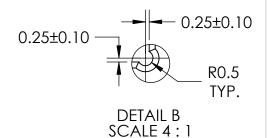




11. PACKAGING DETAIL







COMPONENT ORIENTATION

MODEL NUMBER	SUFFIX	REEL	QUANTITY
MODEL NOMBER	SOLLIV	DIAMETER	PER REEL
SPQ0410HR5H-B	-7	13"	5,700

TAPE & REEL	PER EIA-481
II ABFI	LABEL APPLIED TO EXTERNAL PACKAGE & DIRECT TO REEL.

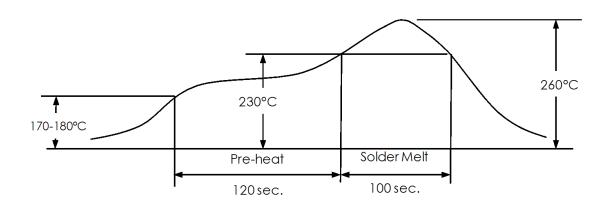
Note:

Dimensions are in milimeters unless otherwise specified.





12. SOLDER FLOW PROFILE



Stage	Temperature Profile	Time (maximum)
Pre-heat	170 ~ 180°C	120 sec.
Solder Melt	Above 230°C	100 sec.
Peak	260°C maximum	30 sec.

13. ADDITIONAL NOTES

- Shelf life: Twelve (12) months when devices are to be stored in factory supplied, (A) unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.

 MSL (moisture sensitivity level) Class 2a.
- Do not pull a vacuum over port hole of the microphone. Pulling a vacuum over the port hole can damage the device.
- Do not board wash after the reflow process. Board washing and cleaning agents (D) can damage the device. Do not expose to ultrasonic processing or cleaning.
- Do not brush board after the reflow process. Brushing the board with/without (E) solvents can damage the device.
- Do not insert any object in port hole of device at any time as this can damage the (F) device.
- Number of reflow Recommend no more than 3 cycles.
- Do not apply air pressure into the port hole. Air pressure over 30 psi can damage the device.





14. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	100 cycles of air-air thermal shock from -40°C to
memai shock	+125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature	+105°C environment for 1,000 hours. (IEC 68-2-2 Test
Storage	Ba)
Low Temperature	-40°C environment for 1,000 hours. (IEC 68-2-2 Test Aa)
Storage	-40 C environment for 1,000 hoors. (IEC 60-2-2 fest Adj
High Temperature Bias	+105°C environment while under bias for 1,000 hours.
	(IEC 68-2-2 Test Ba)
Low Temperature Bias	-40°C environment while under bias for 1,000 hours.
Low temperature bias	(IEC 68-2-2 Test Aa)
Temperature / Humidity	+85°C/85% R.H. environment while under bias for 1,000
Bias	hours. (JESD22-A101A-B)
	4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y
Vibration	and Z direction with peak acceleration of 20g. (MIL
	883E, Method 2007.2, A)
	3 discharges at +/-8kV direct contact to lid when unit
Electrostatic Discharge	is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV
Licenostane Discharge	direct contact to I/O pins. (MIL 883E, Method 3015.7)
	alloct contact to 1/0 pins. (Mile oode, Montod 3013.7)
Reflow	5 reflow cycles with peak temperature of +260°C.
Mechanical Shock	3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2-
MECHANICALSHOCK	27, Test Ea)





15. SPECIFICATION REVISIONS

Revision	Detailed Specification Changes	Date
Α	Initial Release (C10112979)	11-11-11

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